

**ADS7883EVM, ADS7884EVM, ADS7885EVM,
ADS7886EVM, ADS7887EVM, ADS7888EVM**

User's Guide



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1	EVM Overview	5
1.1	Features	5
2	Introduction.....	6
3	Analog Interface.....	7
3.1	Signal Conditioning	7
3.2	Reference	8
4	Digital Interface.....	9
5	Power Supplies	10
6	Using the EVM	11
6.1	As a Reference Board	11
6.2	As a Prototype Board	11
6.3	As a Software Test Platform	11
7	ADS788xEVM BOM	12
8	ADS788xEVM LAYOUT	14
9	ADS788xEVM Schematics	16
	Important Notices	17

List of Figures

1	Input Buffer Circuit.....	7
2	Top: Layer 1.....	14
3	Ground Plane: Layer 2	14
4	Power Plane: Layer 3.....	15
5	Bottom: Layer 4.....	15

List of Tables

1	Device Comparision Summary.....	6
2	Analog Input Connector	7
3	Jumper Setting	8
4	Serial Control Connector P2.....	9
5	Power-Supply Test Points.....	10
6	Power Connector Pinout	10
7	ADS788xEVM Bill of Materials	12

ADS788xEVM

This user's guide describes the characteristics, operation, and use of the evaluation module (EVM). A complete circuit description as well as schematic diagrams and bill of materials are included for Revision B of the EVMs.

This user's guide describes the characteristics, operation, and use of the [ADS7883EVM](#), [ADS7884EVM](#), [ADS7885EVM](#), [ADS7886EVM](#), [ADS7887EVM](#), and the [ADS7888EVM](#) (ADS788xEVM). These evaluation modules (EVMs) are evaluation boards for the ADS788x devices, series of 12-bit/10-bit/8-bit, 1-MSPS/1.25-MSPS/3-MSPS, high-speed, serial-interface analog-to-digital converters (ADCs). The EVM allows evaluation of all aspects of the [ADS7883](#), [ADS7884](#), [ADS7885](#), [ADS7886](#), [ADS7887](#), and [ADS7888](#) (collectively referred to as the ADS788x) devices. Complete circuit descriptions, schematic diagrams, and bills of material are included in this document.

Throughout this document, the abbreviation *EVM* and the term *evaluation board* are synonymous with the ADS788xEVM. For clarity of reading, the terms *ADS788x* and *ADS788xEVM* refer to all of the devices associated with this document, unless specifically noted.

The following related documents are available through the Texas Instruments web site at www.ti.com.

EVM-Compatible Device Data Sheets

Device	Literature Number	Device	Literature Number
ADS7883	SLAS594	ADS7886	SLAS492
ADS7884	SLAS567	ADS7887	SLAS468
ADS7885	SLAS567	ADS7888	SLAS468
REF1004C-2.5	SBVS002	THS4031	SLOS224
SN74AHC1G125	SCLS377	OPA227	SBOS110

1 EVM Overview

1.1 Features

- Full-featured evaluation board for the ADS788x 12-bit/10-bit/8-bit, 1-MSPS/1.25-MSPS/3-MSPS, single-channel, high-speed serial interface ADCs
- Onboard signal conditioning
- Onboard reference

2 Introduction

The [ADS7883](#) is a 12-bit, 3-MSPS serial-interface ADC. The [ADS7884](#) is a 10-bit, 3-MSPS serial-interface ADC. The [ADS7885](#) is an 8-bit, 3-MSPS serial-interface ADC. The [ADS7886](#) is a 12-bit, 1-MSPS serial-interface ADC. The [ADS7887](#) is a 10-bit, 1.25-MSPS serial-interface ADC. The [ADS7888](#) is an 8-bit, 1.25-MSPS ADC. These devices include a capacitor-based successive approximation register (SAR) ADC with inherent sample-and-hold stages. The serial interface for each ADC is controlled by two signals: chip select and the serial shift clock. The input signal is sampled with the falling edge of chip select, and the serial shift clock is used as the conversion and the serial data output clock. [Table 1](#) summarizes the devices and the respective features.

Table 1. Device Comparison Summary

Device	No of Bits	MSPS	Package
ADS7883	12	3	SOT23-6
ADS7884	10	3	SOT23-6
ADS7885	8	3	SOT23-6
ADS7886	12	1	SOT23-6, SC70
ADS7887	10	1.25	SOT23-6, SC-70
ADS7888	8	1.25	SOT23-6, SC-70

The devices operate from 2.35 V up to 5.25 V, and are available in a 6-pin SOT23 package. Low power consumption and a small size make these devices ideally suitable for battery-powered, portable applications. The ADS7886, ADS7887, and ADS7888 are also available in a 6-pin SC70 package. All device versions are specified for operation from –40°C to 125°C.

The high level of the digital input to the device is not limited to device VDD. This design means that the digital input can go as high as 5.25 V when the device supply is 2.35 V. This feature is useful when digital signals are coming from another circuit with different supply levels.

3 Analog Interface

The ADS788x ADC has one analog input pin. A signal for the input pin can be applied at connector P1, pin 2 (as shown in Table 2), or applied to the center pin of SMA connector J1. The input range of the converter set by the power-supply voltage applied at pin 1. For example, if $V_{DD} = 2.35\text{ V}$, then V_I can range from 0 V up to 2.35 V or 2.35 V_{PP} .

Table 2. Analog Input Connector

Description	Signal Name	Connector and Pin Number		Signal Name	Description
Reserved	N/C	P1.1	P1.2	(+)	VIN
Reserved	N/C	P1.3	P1.4	N/C	Reserved
Reserved	N/C	P1.5	P1.6	N/C	Reserved
Reserved	N/C	P1.7	P1.8	N/C	Reserved
Pin tied to Ground	AGND	P1.9	P1.10	N/C	Reserved
Pin tied to Ground	AGND	P1.11	P1.12	N/C	Reserved
Reserved	N/C	P1.13	P1.14	N/C	Reserved
Pin tied to Ground	AGND	P1.15	P1.16	N/C	Reserved
Pin tied to Ground	AGND	P1.17	P1.18	N/C	Reserved
Reserved	N/C	P1.19	P1.20	EXT_REF	External Reference Input

3.1 Signal Conditioning

The VIN input to the ADS788x is driven with a low-impedance source. In many cases, an input driver is not necessary; however, in cases where the source impedance exceeds $200\ \Omega$, using a buffer helps achieve the rated performance of the converter.

The amplifier circuit shown in Figure 1 is the buffer circuit used on the ADS788xEVM. This circuit consists of the THS4031, a high-speed, low-noise, low-distortion amplifier configured as an inverting gain of 1. The circuit shown in Figure 1 is optimized to achieve the ac (that is, SNR, THD, SFDR, etc.) specifications listed in the respective ADS788x product data sheets. Note that the input circuit may require adjustments to achieve best performance for the test system.

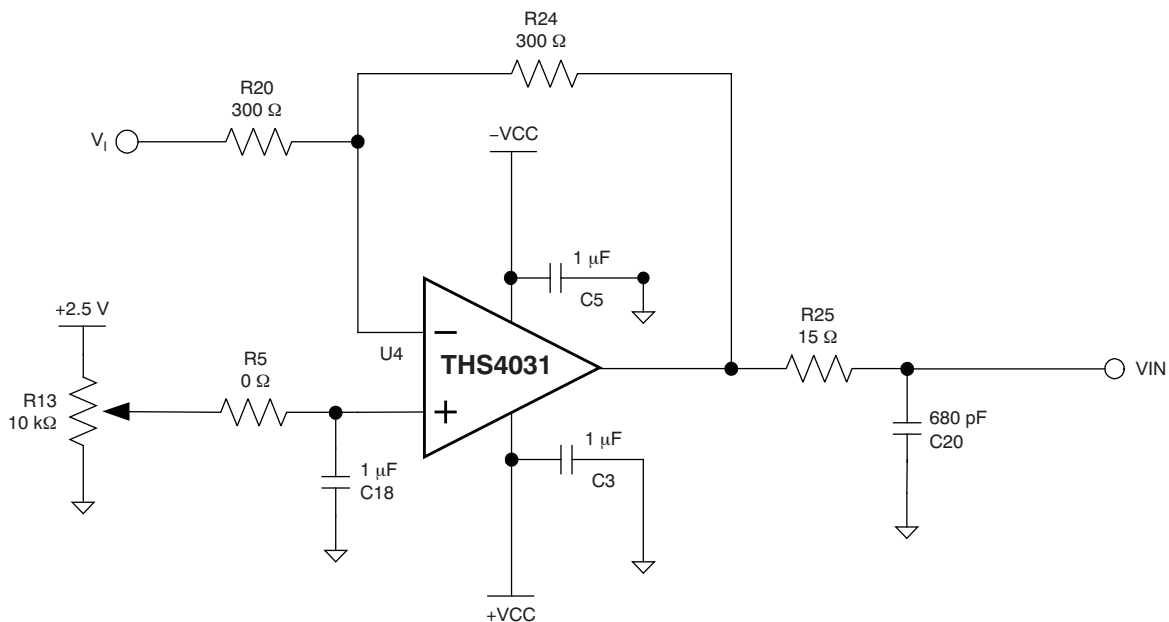


Figure 1. Input Buffer Circuit

The 15-Ω series resistor works with the capacitor, C20, to filter the input signal and isolates the amplifier from the capacitive load. The 680-pF capacitor to ground at the ADC input works with the series resistor to filter the input signal, behaving as a charge reservoir. It provides a short to ground for high-frequency noise and kickback currents when the device switches from hold to sample mode. This external filter capacitor also works with the amplifier to charge the internal sampling capacitor during sampling mode.

The type of input capacitors used in the signal path can make a few decibels of difference in ac performance. TI recommends using either a polypropylene or C0G type capacitor in the input signal path. The polypropylene capacitor causes the least distortion of the input signal and has excellent long-term stability, but is bulky and expensive. The C0G ceramic type is lower cost, comes in smaller packages, and perform well in many applications, but tends to be less stable over time and temperature compared to polypropylene capacitors. The 680-pF capacitors installed on the EVM are low-cost, C0G-type capacitors manufactured by TDK Corporation.

3.2 Reference

The ADS788x reference voltage is derived internally from the supply voltage. Consequently, the supply voltage to these converters must be driven with a low-impedance source and be decoupled to ground at the chip. It is recommended that, at least, a pair of 1-μF and 10-nF decoupling capacitors be placed close to the chip. Use wide, low-impedance traces from these capacitors to the VDD pin.

The converters themselves draw very little current from the supply lines. Therefore, the supply voltage pin for the ADS788x can be connected directly to the system supply, or to a low-noise and low-drift reference chip. The EVM provides users the option to power the ADC from either the analog supply voltage applied at TP4 or from an onboard 2.5-V reference chip.

Table 3. Jumper Setting ⁽¹⁾

Reference Designator	Description	Jumper Setting	
		1-2	2-3
SJP1	Set negative supply of U2 to ground.	Installed ⁽²⁾	Not installed
	Select negative supply of U2 to –VCC.	Not installed	Installed
SJP2	Set negative supply of U4 to ground.	Installed	Not installed
	Select negative supply of U4 to –VCC.	Not installed	Installed ⁽²⁾
W1	Apply CS from P2.1 to the ADC chip select pin	Installed	Not installed
	Apply FS from P2.7 to the ADC chip select pin	Not installed	Installed ⁽²⁾
W2	Set BVDD to +5VD	Installed	Not installed
	Set BVDD to +3.3VD	Not installed	Installed ⁽²⁾
W3	Set 2.5 V to W4 (pin 3)	Installed ⁽²⁾	Not installed
	Set user applied voltage to W4 (pin 3)	Not installed	Installed
W4	Set DUT power supply pin to 5 V	Installed ⁽²⁾	Not installed
	Set DUT power supply pin to voltage on W3 (pin 2).	Not installed	Installed

⁽¹⁾ These jumper settings are for revision B of the ADS788xEVM printed circuit board (PCB).

⁽²⁾ Factory-installed.

4 Digital Interface

The ADS788xEVM is designed for easy interfacing to multiple platforms. Samtec part numbers SSW-110-22-F-D-VS-K and TSM-110-01-T-DV-P provide a convenient dual row header/socket combination at P1 and P2. Consult Samtec at www.samtec.com or 1-800-SAMTEC-9 for a variety of mating connector options.

The digital input and output signals for the converter is made available via connector P2 on the ADS7886EVM/ADS7887EVM/ADS7888EVM, see [Table 4](#) for connector pin-out.

Table 4. Serial Control Connector P2

Description	Signal Name	Connector and Pin Number		Signal Name	Description
Chip Select	$\overline{\text{CS}}$	P2.1	P2.2	N/C	Reserved
Serial Clock	SCLK	P2.3	P2.4	DGND	Ground
Reserved	N/C	P2.5	P2.6	N/C	Reserved
Frame Sync	FS	P2.7	P2.8	N/C	Reserved
Reserved	N/A	P2.9	P2.10	DGND	Ground
Reserved	N/C	P2.11	P2.12	N/C	Reserved
Serial Data Out	SDO	P2.13	P2.14	N/C	Reserved
Reserved	N/C	P2.15	P2.16	N/C	Reserved
Reserved	N/C	P2.17	P2.18	DGND	Ground
Reserved	N/C	P2.19	P2.20	N/A	Reserved

I/O buffer and level translation functions may not be required for many applications. These devices have a high-level digital input that is not limited to the device VDD voltage, but to 5.25 V. This different limit means that the ADC can be powered up at 2.35 V and interfaced to 5-V logic directly.

The ADS788x output low-level and high-level voltages are 0.4 V and (VDD – 0.2 V), respectively. If the ADS788x is powered up at 5 V and the host processor is at 1.8 V, then level translation may be required. The output level translation function (done by U6 on the EVM) may be required depending on the host processor. Check the specific host processor data sheet for input logic levels.

5 Power Supplies

The EVM accepts four power supplies.

- A dual $\pm V_S$ dc supply for the dual-supply operational amplifiers. Recommended: ± 6 VDC.
- A single 5-V dc supply for the analog section of the board (ADC + reference).
- A single 5-V or 3.3-V dc supply for the digital section of the board (output buffers U6).

There are two ways to provide these voltages.

1. Wire in voltages at test points on the EVM. See [Table 5](#).

Table 5. Power-Supply Test Points

Test Point	Signal	Description
TP1	+VA	Apply +6 VDC. Positive supply for amplifier.
TP2	–VA	Apply –6 VDC. Negative supply for amplifier.
TP3	+BVDD	Apply 3.3 VDC or 5 VDC. See the ADC data sheet for full range.
TP4	+AVCC	Apply 5 VDC.

2. Use the power connector J2, and derive the voltages elsewhere. The pin out for this connector is shown in [Table 6](#). If using this connector, then set W1 jumper to connect +3.3VD or +5VD from connector to +BVDD. Short between pins 1-2 to select +5VD, or short between pins 2-3 to select +3.3VD as the source for the digital buffer voltage supply (+BVDD).

Table 6. Power Connector Pinout

Signal	J1 Pin		Signal
+VA (6 V)	1	2	–VA (–6 V)
+5VA	3	4	N/C
DGND	5	6	AGND
N/C	7	8	N/C
+3.3VD	9	10	+5VD

The voltage applied to the VDD pin of the ADC is controlled by W4. If pins 1 and 2 are shorted, then +5VCC is applied to the ADC. If pins 2 and 3 are shorted, then the reference voltage selected by W3 powers the ADC. See [Table 3](#) or the schematic drawings at the end of this user's guide to determine how power is supplied to the various ICs on the board.

6 Using the EVM

The ADS788xEVM serves three functions:

1. As a reference design
2. As a prototype board; and
3. As software test platform

6.1 As a Reference Board

As a reference design, the ADS788xEVM contains the essential circuitry to showcase the ADC. This essential circuitry includes the input amplifier, reference circuit, and buffers. The analog input circuit is optimized for a 100-kHz input signal; therefore, users may need to adjust the resistor and capacitor values to accommodate higher frequencies and different test systems. In ac-type applications where signal distortion is concern, care should be taken to ensure that polypropylene or C0G-type capacitors are used in the signal path.

The design and layout of this EVM, in conjunction with the individual ADC data sheet, can be used as a guide when incorporating this ADC into a user system board.

6.2 As a Prototype Board

As a prototype board, the buffer circuit consists of resistor pads for configuring the input as either inverting or noninverting. The input circuit can be modified to accommodate user prototype needs, such as evaluating another amplifier or limiting noise for best performance. The analog, power, and digital connectors can be made to plug into a standard 0.1-inch breadboard or ribbon cables to interface directly to FPGAs or processors.

6.3 As a Software Test Platform

As a software test platform, connectors P1 and P2 plug into the serial interface connectors of the 5-6K interface card. The 5-6K interface card plugs into the TMS320C5000™ DSP and TMS320C6000™ DSP starter kits (DSK). See the [5-6K interface card](#) user's guide ([SLAU104](#)) for more information.

7 ADS788xEVM BOM

Table 7 contains a complete bill of materials for the ADS788xEVM . Schematic diagrams are also provided for reference. Contact the Product Information Center or e-mail dataconvapps@list.ti.com for questions regarding this EVM.

Table 7. ADS788xEVM Bill of Materials

Item No.	QTY	Value	Reference Designators	Footprint	Mfg	Mfg Part number	Description
1	5	NI	R1 R2	603	NOT INSTALLED	NOT INSTALLED	
			R3 R4 R26				
2	1	0	R5	805	Panasonic-ECG or Alternate	ERJ-6GEY0R00V	RES 0.0 OHM 1/10W 5% 0805 SMD
3	5	0	R6 R7 R9	603	Panasonic-ECG or Alternate	ERJ-3GEY0R00V	RES ZERO OHM 1/16W 5% 0603 SMD
			R11 R12				
4	2	100	R8 R15	603	Panasonic-ECG or Alternate	ERJ-3EKF1000V	RES 100 OHM 1/16W 1% 0603 SMD
5	1	140	R16	603	Yageo America or Alternate	9T06031A1400DBHFT	RES ZERO OHM 1/16W 5% 0603 SMD
6	4	NI	R10 R21	805	Not Installed	Not Installed	
			R22 R23				
7	1	10k	R13	BOURNS_32X4W	Bourns	3214W-1-103E	TRIMPOT 10K OHM 4MM TOP ADJ SMD
8	1	1k	R14	603	Yageo America or Alternate	9C06031A1001FKHFT	RES 1.00K OHM 1/10W 1% 0603 SMD
9	2	10k	R18 R19	603	Panasonic ECG or Alternate	ERJ-3EKF1002V	RES 10.0K OHM 1/16W 1% 0603 SMD
10	1	15	R25	603	Panasonic-ECG or Alternate	ERJ-3EKF15R0V	RES 15.0 OHM 1/16W 1% 0603 SMD
11	2	300	R20 R24	805	Yageo America or Alternate	9C08052A3000FKHFT	RES 300 OHM 18W 1% 0805 SMD
12	1	0	R28	1206	Panasonic-ECG or Alternate	ERJ-8GEY0R00V	RES ZERO OHM 1/4W 5% 1206 SMD
13	1	NI	C1	1206	Not Installed	Not Installed	
14	4	1uF	C2 C3 C4	603	TDK Corporation or Alternate	C1608X5R1A105KT	CAP CER 1.0UF 10V X5R 10% 0603
			C9				
15	2	1uF	C5 C18	805	TDK Corporation or Alternate	C2012X7R1E105K	CAP CER 1.0UF 25V X7R 0805 T/R
16	1	0.47uF	C8	603	TDK Corporation or Alternate	C1608X5R1A474K	CAP CER .47UF 10V X5R 10% 0603
17	2	NI	C11 C19	805	Not Installed	Not Installed	
18	1	0.1uF	C15	603	TDK Corporation or Alternate	C1608X7R1E104K	CAP CER .10UF 25V X7R 10% 0603
19	1	2.2uF	C17	603	TDK Corporation or Alternate	C1608X5R1A225MT	CAP CER 2.2UF 6.3V X5R 20% 0603
20	1	10nF	C13	603	TDK Corporation or Alternate	C1608C0G1H100D	CAP CER 10PF 50V C0G 0603
21	4	10uF	C22 C23	805	TDK Corporation or Alternate	C2012X5R0J106M	CAP CER 10UF 6.3V X5R 20% 0805
			C24 C25				
22	4	10uF	C26 C27	1206	TDK Corporation or Alternate	C3216X5R1C106KT	CAP CER 10UF 16V X5R 20% 1206

Table 7. ADS788xEVM Bill of Materials (continued)

			C28 C29				
23	1	680pF	C20	603	TDK Corporation or Alternate	C1608C0G1H681J	CAP CER 680PF 50V C0G 5% 0603
24	4	1000pF	C36 C37	603	TDK Corporation or Alternate	C1608C0G1H102J	CAP CER 1000PF 50V C0G 5% 0603
			C38 C39				
25	3	MMZ2012 R601A	L1 L3 L4	1206	TDK Corporation	MMZ2012R601A	FERRITE CHIP 600 OHM 500MA 0805
26	12	NI	C6 C7 C10 C12 C14 C21 C30 C31 C32 C33 C34 C35	603	NOT INSTALLED	NOT INSTALLED	Multilayer Ceramic - 0805 Size
27	1	REF3225	U3	SOT23-6	Texas Instruments	REF3225AIDBVT	low drift reference REF 3225, 3230, 3233, 3240
28	2	THS4031	U2 U4	8-SOP(D)	Texas Instruments	THS4031CD	100-MHz LOW-NOISE HIGH SPEED AMPLIFIER
29	1	DUT	U5	6-SOT(DBV)	Texas Instruments	ADS788xSDBDBVR	
30	1	SN74LVC 1G07	U6	5-SOT(DBV)	Texas Instruments	SN74LVC1G07DBVR	SINGLE BUS BUFFER GATE WITH OUTPUT ENABLE
31	2		W1 W2	3pos_jump	Samtec	TSW-103-07-L-S	3 Position Jumper _ .1" spacing
32	2		W3 W4	3-POS_JUMPER_2MM	Samtec	TMM-103-03-T-S	2mm low profile
33	2	10X2X.1	P1 P2	10X2X.1_SMT_PLUG and SOCKET	Samtec	SSW-110-22-S-D-VS	0.025" SMT SOCKET - BOTTOM SIDE OF PWB
34	2				Samtec	TSM-110-01-T-D-V-P	0.025" SMT PLUG - TOP SIDE of PWB
35	1	SMA_PC B_MT	J1	SMA_JACK	Johnson Components Inc.	142-0701-301	Right Angle SMA Connector
36	1	Power Supply	J2	5X2X.1_SMT_SOCKE T	Samtec	SSW-105-22-S-D-VS	0.025" SMT SOCKET - BOTTOM SIDE OF PWB
37	1				Samtec	TSM-105-01-T-D-V-P	0.025" SMT PLUG - TOP SIDE of PWB
38	2		SJP1 SJP2	SJP3			
39	10	TP_.025	TP1 TP2 TP3 TP4 TP5 TP6 TP7 TP9 TP12 TP15	test_point2	Keystone Electronics	5000K-ND	TEST POINT PC MINI .040"D RED
40	5	TP_.025	TP8 TP10	test_point2	Keystone Electronics	5001K-ND	TEST POINT PC MINI .040"D BLACK
			TP11 TP13				
			TP14				

Notes:

- On the ADS7883EVM, [item 29](#) is the ADS7883SDBVT device.
- On the ADS7884EVM, [item 29](#) is the ADS7884SDBVT device.
- On the ADS7885EVM, [item 29](#) is the ADS7885SDBVT device.
- On the ADS7886EVM, [item 29](#) is the ADS7886SDBVT device.
- On the ADS7887EVM, [item 29](#) is the ADS7887SDBVT device.
- On the ADS7888EVM, [item 29](#) is the ADS7888SDBVT device.

8 ADS788xEVM LAYOUT

This section contains the layout drawings for revision B of the ADS788xEVM PCB.

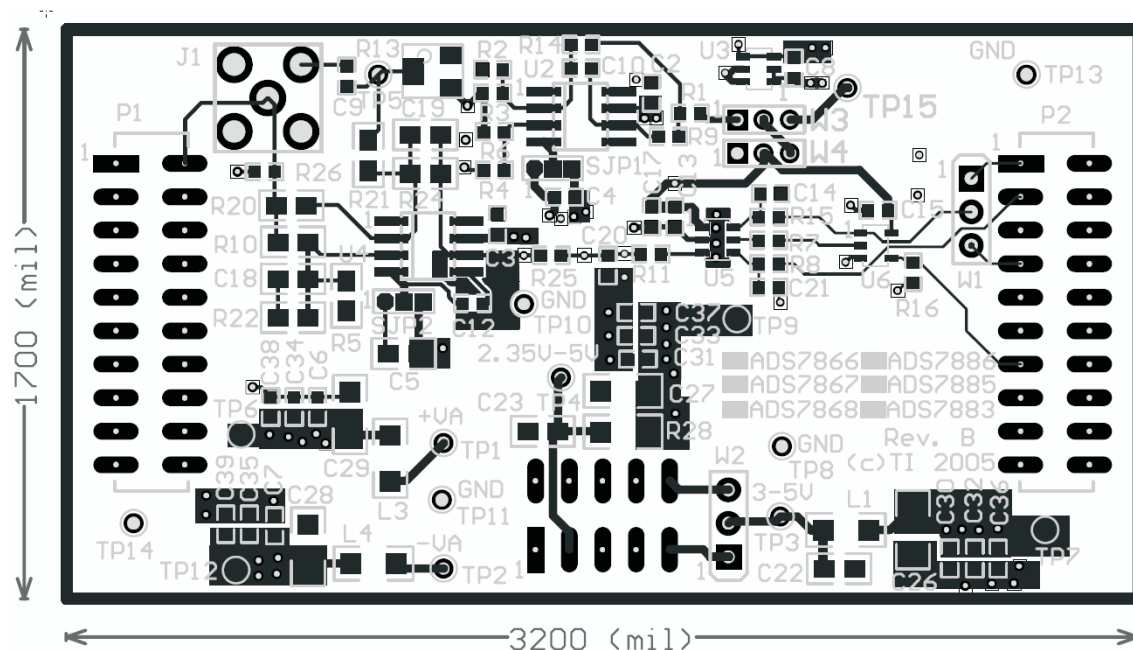


Figure 2. Top: Layer 1

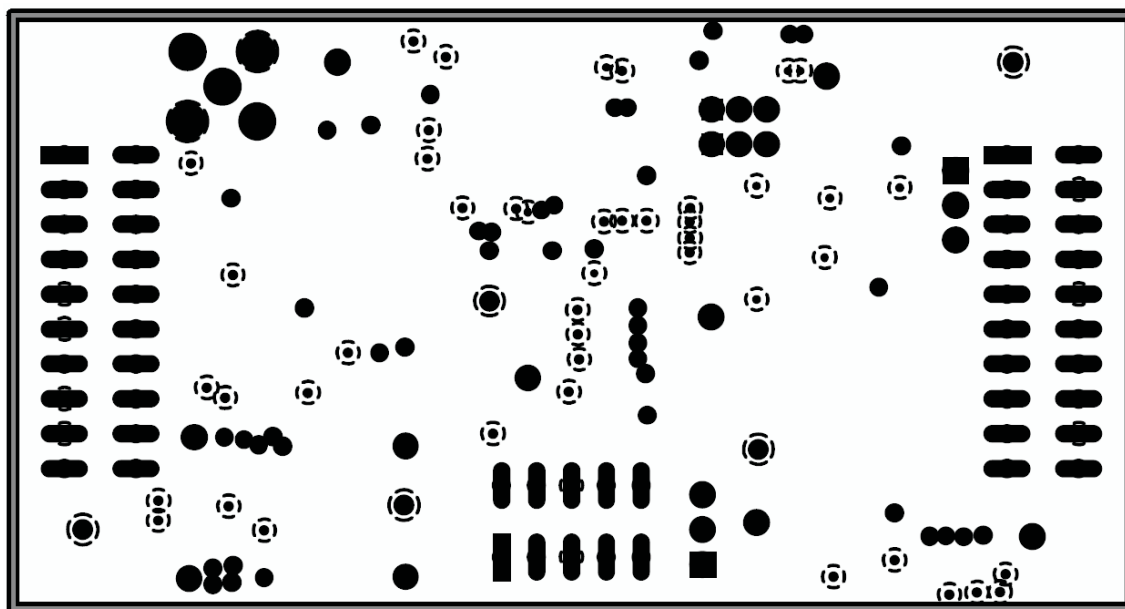


Figure 3. Ground Plane: Layer 2

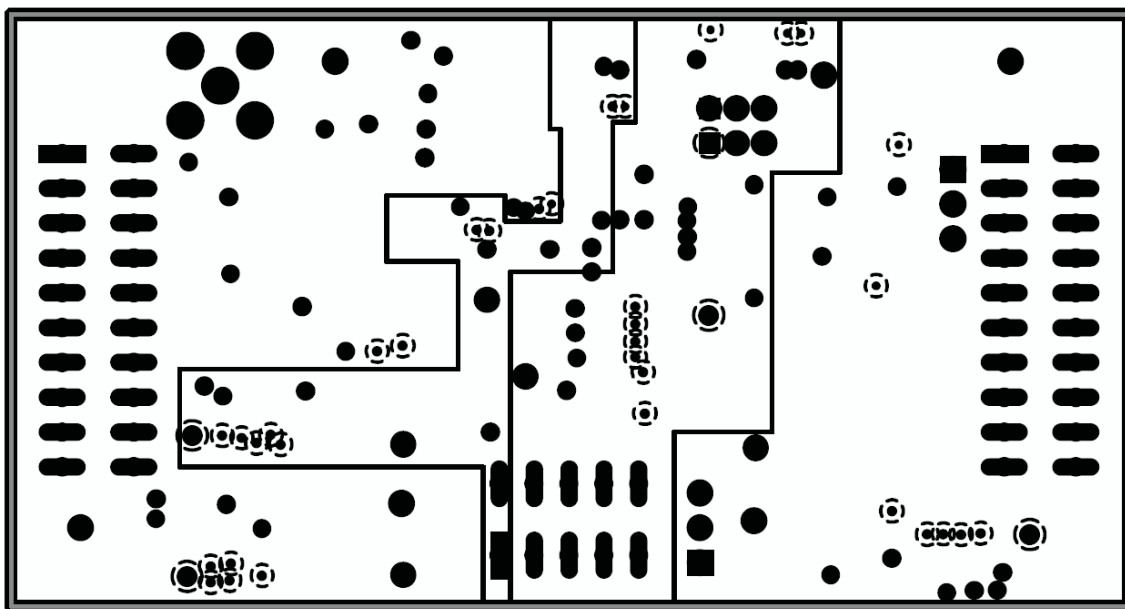


Figure 4. Power Plane: Layer 3

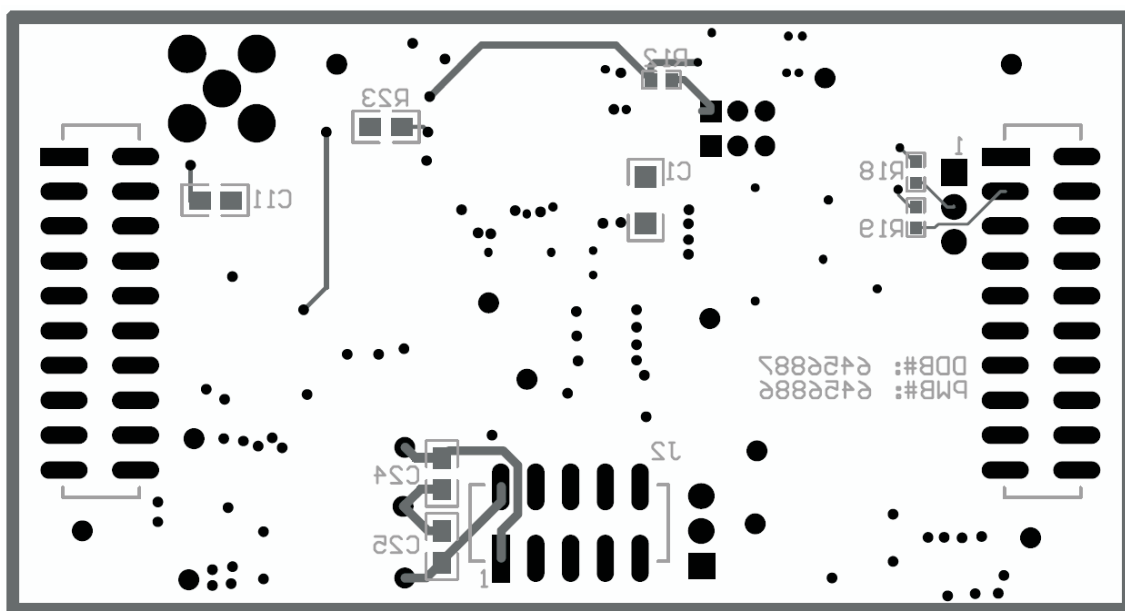
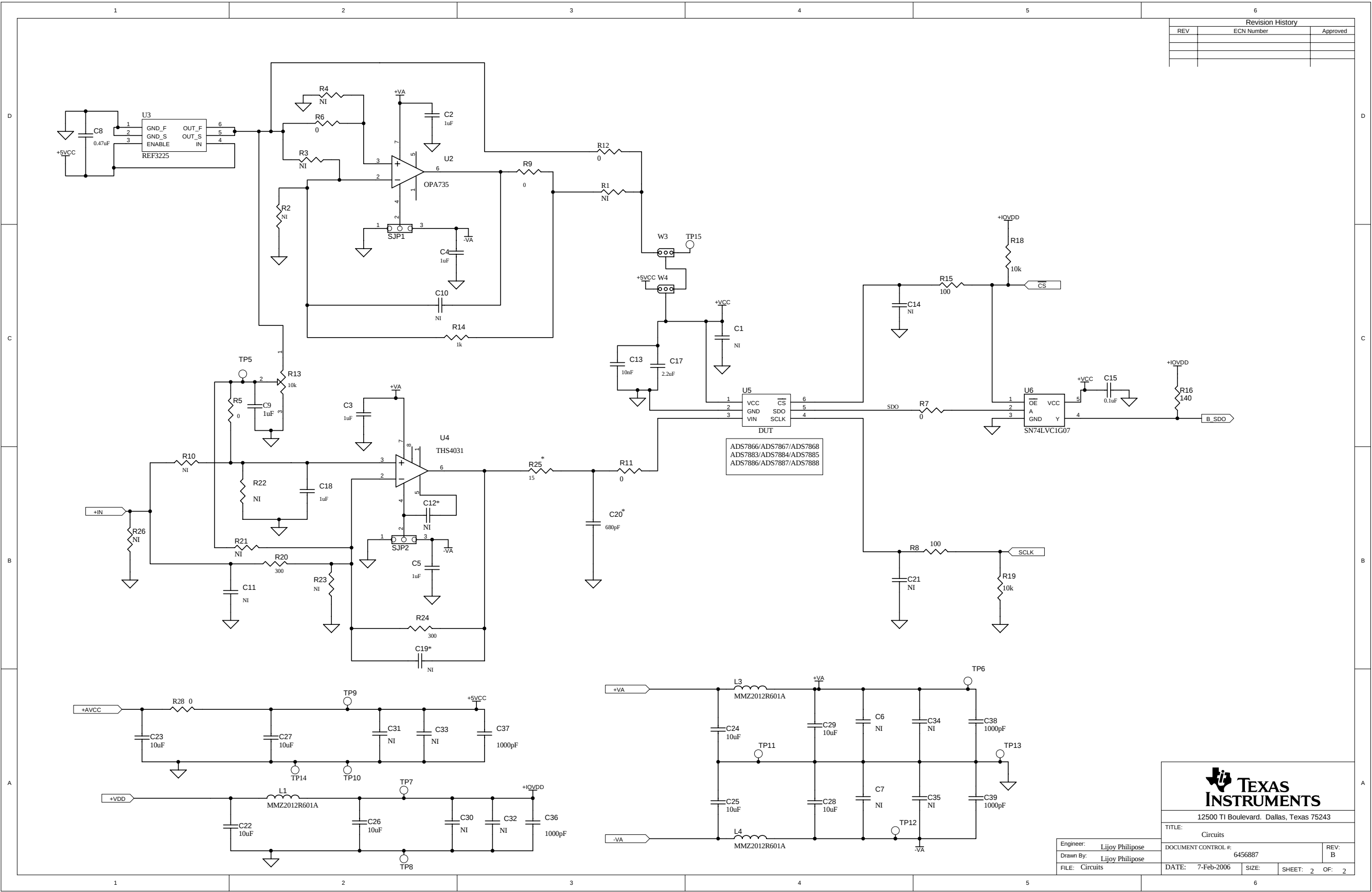


Figure 5. Bottom: Layer 4

9 ADS788xEVM Schematics



Revision History		
REV	ECN Number	Approved



12500 TI Boulevard, Dallas, Texas 75243

TITLE: Circuits		
DOCUMENT CONTROL #: 6456887		
DATE: 7-Feb-2006	SIZE:	SHEET: 2 OF: 2

Engineer: Lijoy Philipose
Drawn By: Lijoy Philipose
FILE: Circuits

REV: B

EVALUATION BOARD/KIT IMPORTANT NOTICE

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 2.35 V to 5.25 V and the output voltage range of 0.4 V and VDD - 0.2 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 30°C. The EVM is designed to operate properly with certain components above 30°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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